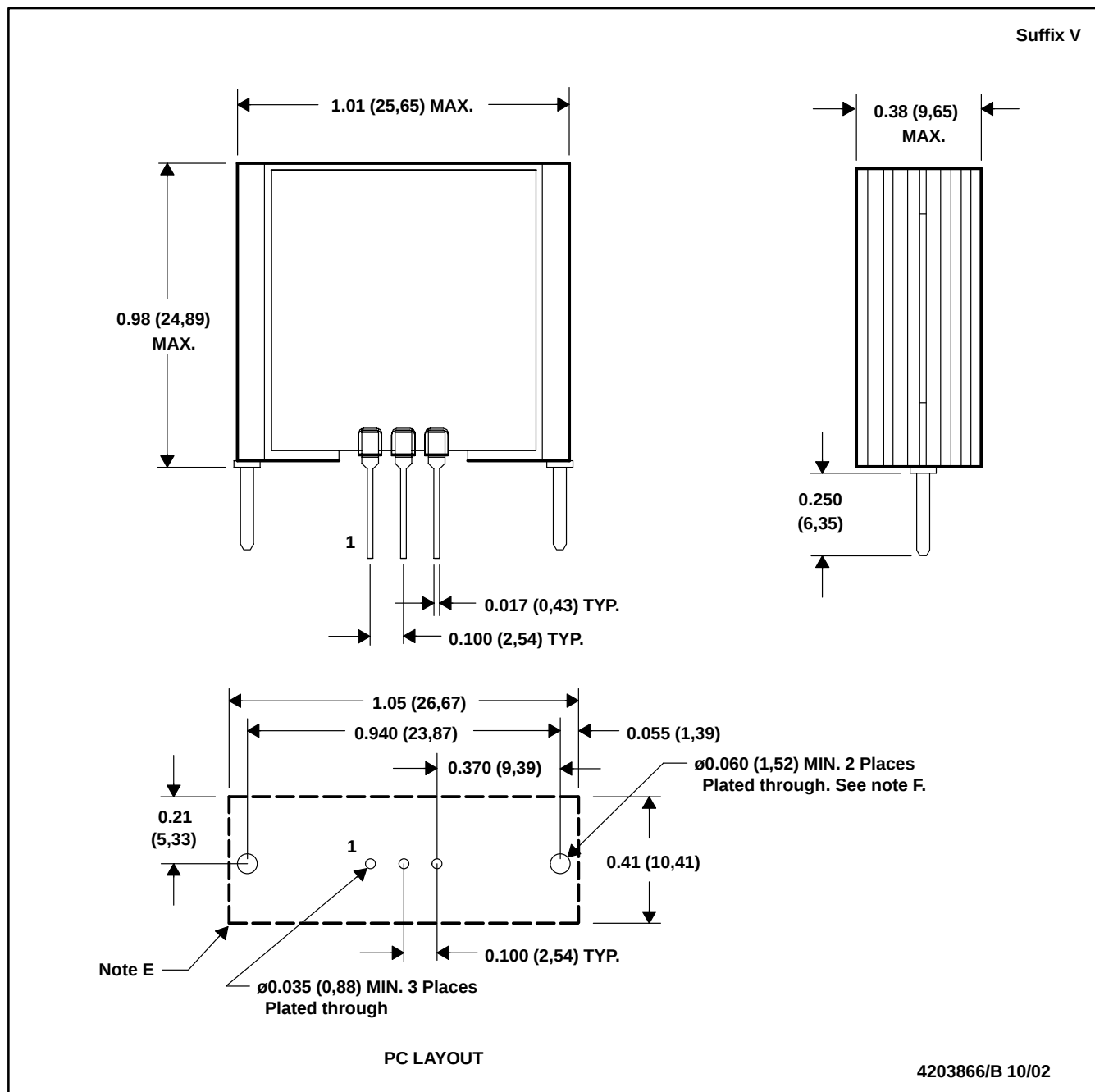


EFF (R-MSIP-T3)

METAL SINGLE-IN-LINE MODULE

Suffix V



- NOTES:
- A. All linear dimensions are in inches (mm).
 - B. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 - D. 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 - E. Recommended mechanical keep out area.
 - F. The case is electrically isolated and can be grounded.

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265